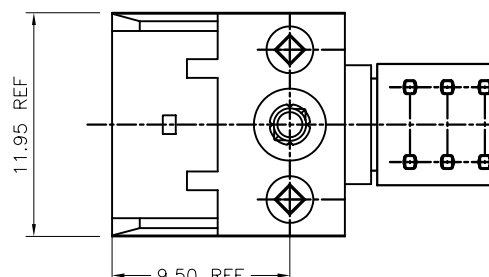
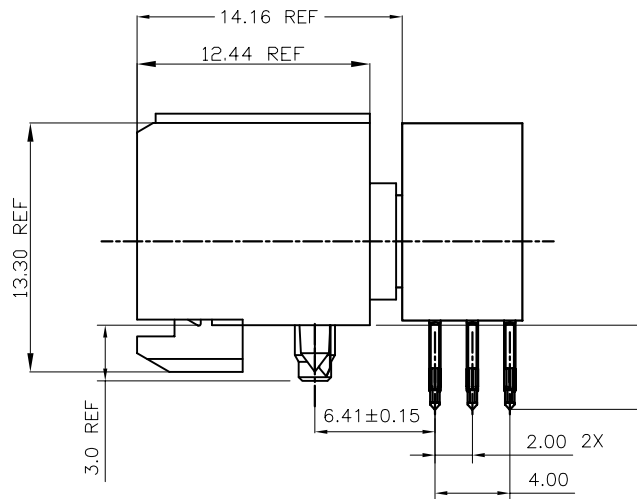
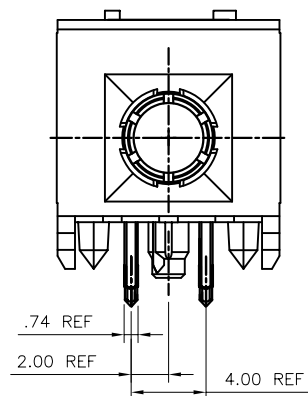


PRODUCT NO.	PCB ATTACHMENT	P.C.B THICKNESS
63734-101	PRESS-PEG	2.4

NOTE 7

PRESS-FIT HOLES	
HOLE DIAMETER	
AFTER PLATING	0.65-0.80
DRILLED HOLE	0.81-0.86
COPPER PLATING	0.025 MIN.
SnPb OR Sn PLATING	0.005-0.015



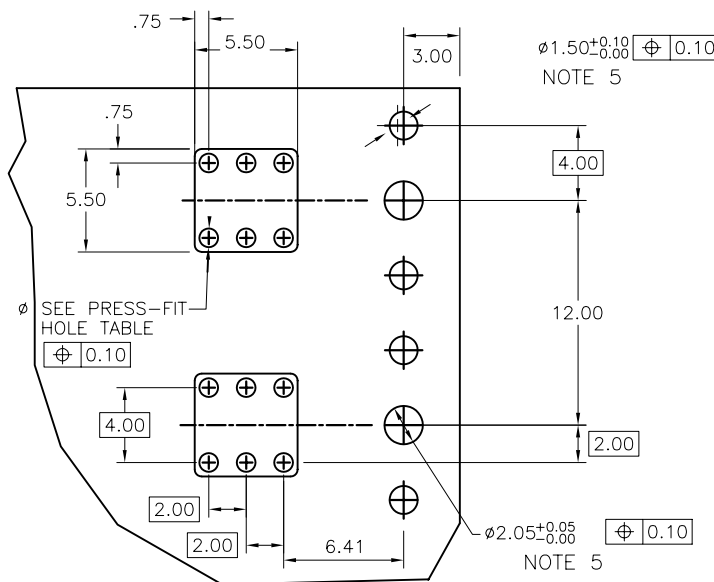
NOTES:

1. BODY MATERIAL: LCP, 30% GLASS-FILLED, FLAME RETARDENT, ACC, UL94-V0
2. TERMINAL MATERIAL: BeCu
3. PLATING SOLDER TAILS: 2.5µm SnPb
4. PLATING CONTACT AREA: 0.80µm Au OVER 1.3µm Ni.
5. INDICATED HOLES ARE UNPLATED
6. PRODUCT MARKING: PART NUMBER & BATCH I.D.
7. ADD "LF" SUFFIX AT THE END OF PART NUMBER FOR LEAD FREE OPTION.
8. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
9. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD OR FOR 20 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.



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RECOMMENDED PC BOARD
HOLE PATTERN
(COMPONENT SIDE)

mat'l. code				surface	ISO 1302	tolerance	ISO 406	projection	product family
SEE NOTES							ISO 1101		METRAL (tm)
ltr	ec'n no	dr	date	tolerances unless otherwise specified					title
A	V82172	MDF	1/13/99	angles	linear	.0±.3		MM	POWER CONNECTOR
B	V01599	JWS	7/13/00			.00±.13			ASSEMBLY, 5 ROW
C	V05-0183	DAI	04/14/05	0'±2'		.000±.0051		scale 1:1	
D	M06-0277	MHT	7/22/06	dr	M.FETROW	12/16/98			dwg no
E	M07-0111	MHT	2/14/07	engr	C.PENDLETON	12/16/98			sheet 1 of 1 size
F	M08-0134	MHT	5/14/08	chr	C.PENDLETON	12/16/98			63734 A3
				appd	C.PENDLETON	12/16/98			type
sheet	revision	F							Product Customer Drawing
index	sheet	1							

form A3